



DMNH6042SSDQ

60V DUAL N-CHANNEL 175°C MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C		
	50mΩ @ V _{GS} = 10V	16.7A		
60V	65mΩ @ V _{GS} = 4.5V	14.6A		

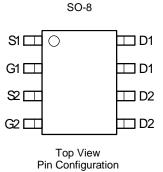
Description and Applications

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Engine Management Systems
- Body Control Electronics
- DC-DC Converters



Top View

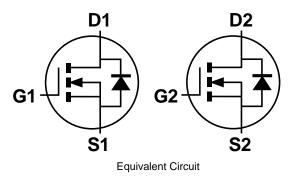


Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low R_{DS(ON)} Minimizes Power Losses
- Low Q_G Minimizes Switching Losses
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.076 grams (Approximate)



Ordering Information (Note 5)

Part Number	Case	Packaging
DMNH6042SSDQ-13	SO-8	2,500/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

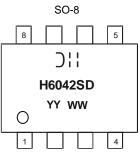
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/quality/product_compliance_definitions.html.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Notes:



Children Strength 2018
Code Marking Code
Code Marking Code
Code Marking
YY = Year (ex: 16 = 2016)
WW = Week (01 - 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V _{DSS}	60	V		
Gate-Source Voltage	V _{GSS}	±20	V		
	Steady State	T _A = +25°C T _A = +70°C	ID	5.3 4.4	А
Continuous Drain Current (Note 7) $V_{GS} = 10V$	Steady State	T _C = +25°C T _C = +100°C	I _D	16.7 14	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I _{DM}	35	А		
Maximum Continuous Body Diode Forward Current	I _S	2.3	А		
Avalanche Current (Note 8) L = 10mH	I _{AS}	3.5	А		
Avalanche Energy (Note 8) L = 10mH			E _{AS}	65	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Units	
Total Power Dissipation (Note 6)		PD	1.5	W	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Р	100	°C/W	
memai Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	61		
Total Power Dissipation (Note 7)		PD	2.1	W	
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	D	72		
member (Note 7)	t<10s	R _{θJA}	44	°C/W	
Thermal Resistance, Junction to Case (Note 7)	R _{ejc}	7.25			
Operating and Storage Temperature Range		TJ, T _{STG}	-55 to +175	°C	

Electrical Characteristics (@T_A= +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)					-		
Drain-Source Breakdown Voltage	BV _{DSS}	60	—	—	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}		_	1	μA	$V_{DS} = 60V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	—	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V _{GS(TH)}	1.0	—	3.0	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Passa		34	50	mΩ	$V_{GS} = 10V, I_D = 5.1A$	
	R _{DS(ON)}		45	65	11152	$V_{GS} = 4.5V, I_D = 4.4A$	
Diode Forward Voltage	V _{SD}		0.8	1.2	V	$V_{GS} = 0V, I_{S} = 2.6A$	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	CISS	_	584		pF	V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	C _{OSS}	_	83		pF		
Reverse Transfer Capacitance	C _{RSS}	_	24		pF		
Gate Resistance	R _G		3.8	—	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_G		4.2	—	nC	V _{DS} = 44V, I _D = 5.2A	
Total Gate Charge (V _{GS} = 10V)	Q_G		8.8	_	nC		
Gate-Source Charge	Q_{GS}		1.8	—	nC		
Gate-Drain Charge	Q _{GD}	_	1.8		nC		
Turn-On Delay Time	t _{D(ON)}	_	3.4	_	ns		
Turn-On Rise Time	t _R	_	1.9	_	ns	V _{GS} = 10V, V _{DS} = 30V,	
Turn-Off Delay Time	t _{D(OFF)}	_	10.1	_	ns	$R_G = 6\Omega, I_D = 1A$	
Turn-Off Fall Time	tF	_	4.5		ns	7	
Body Diode Reverse Recovery Time	t _{RR}		12.9		ns	- I _F = 2.6A, di/dt = 100A/μs	
Body Diode Reverse Recovery Charge	Q _{RR}	_	5.4	—	nC		

Notes: 6. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

7. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.

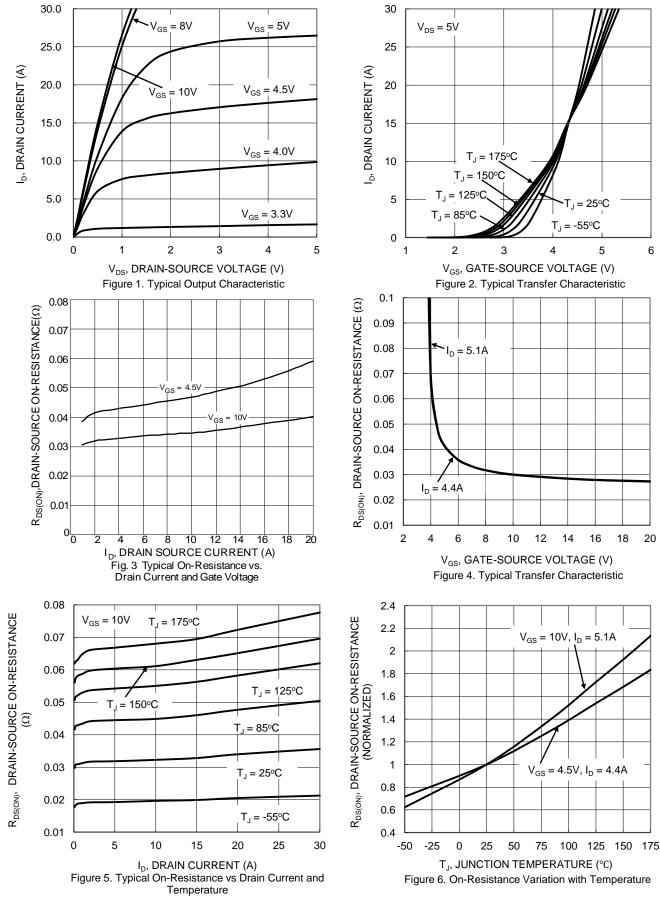
8. I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$.

9. Short duration pulse test used to minimize self-heating effect.

10. Guaranteed by design. Not subject to product testing.

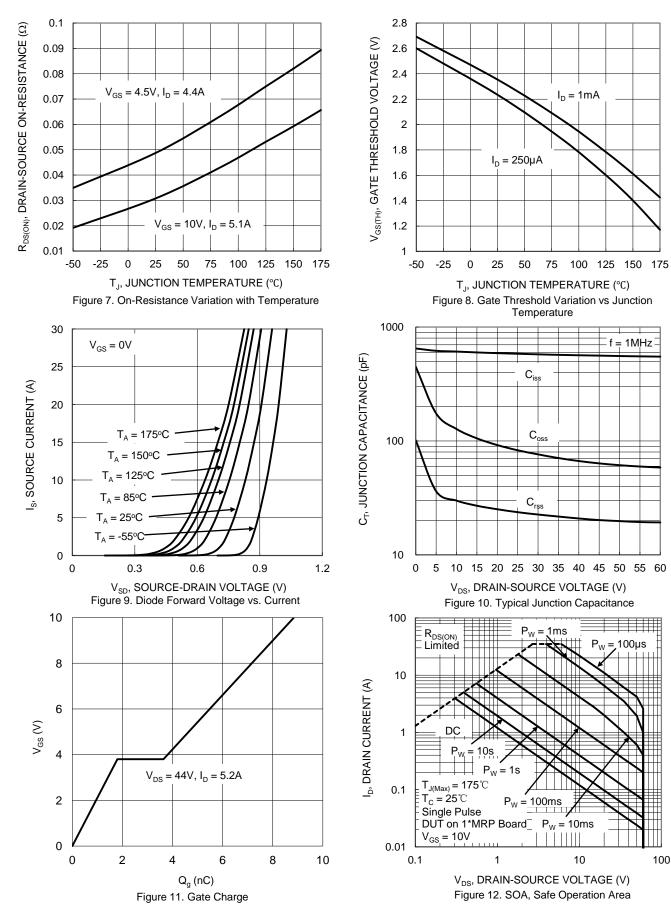


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DMNH6042SSDQ Document number: DS37829 Rev. 4 - 2

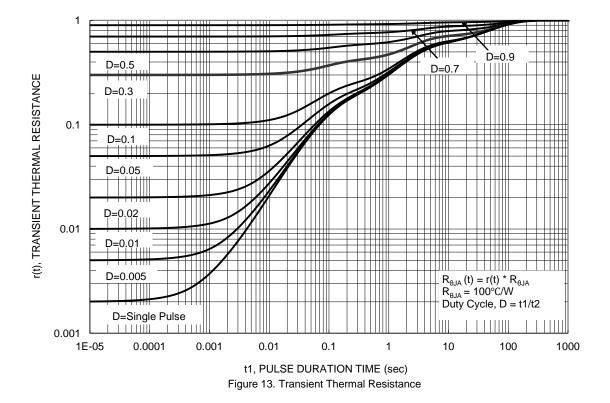




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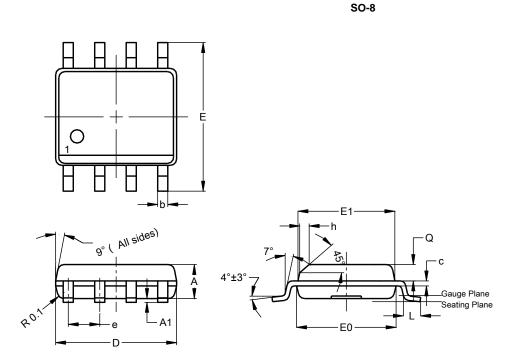






Package Outline Dimensions

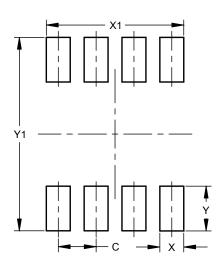
Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-8							
Dim	Dim Min Max Typ						
A	1.40	1.50	1.45				
A1	0.10	0.20	0.15				
b	0.30	0.50	0.40				
С	0.15	0.25	0.20				
D	4.85	4.95	4.90				
ш	5.90	6.10	6.00				
E1	3.80	3.90	3.85				
E0	3.85	3.95	3.90				
e	I	I	1.27				
h	_	_	0.35				
L	0.62	0.82	0.72				
Q	0.60	0.70	0.65				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-8

Dimensions	Value (in mm)			
С	1.27			
Х	0.802			
X1	4.612			
Y	1.505			
Y1	6.50			



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